BLF2324M8LS200P

Power LDMOS transistor

AMPLEON

Rev. 2 — 1 September 2015

Product data sheet

1. Product profile

1.1 General description

200 W LDMOS power transistor for industrial applications at frequencies from 2300 MHz to 2400 MHz.

Table 1. Typical performance

Typical RF performance at $T_{case} = 25$ °C in a common source class-AB production test circuit.

Test signal	f	I_{Dq}	V _{DS}	$P_{L(AV)}$	G_p	η_D	ACPR _{5M}
	(MHz)	(mA)	(V)	(W)	(dB)	(%)	(dBc)
1-carrier W-CDMA	2300 to 2400	1740	28	60	17.2	32	-37 <u>[1]</u>

^[1] Test signal: 3GPP test model 1; 64 DPCH; PAR = 7.2 dB at 0.01 % probability on CCDF.

1.2 Features and benefits

- Excellent ruggedness
- High efficiency
- Low thermal resistance providing excellent thermal stability
- Designed for broadband operation (2300 MHz to 2400 MHz)
- Lower output capacitance for improved performance in Doherty applications
- Designed for low memory effects providing excellent pre-distortability
- Internally matched for ease of use
- Integrated ESD protection
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

■ RF power amplifiers for industrial and multi carrier applications in the 2300 MHz to 2400 MHz frequency range

2. Pinning information

Table 2. Pinning

Description	Simplified outline	Graphic symbol
drain1		
drain2	1 2	
gate1	5	3
gate2	3 4	5
source	[1]	2 sym117
	drain1 drain2 gate1 gate2	drain1 drain2 gate1 gate2

[1] Connected to flange.

3. Ordering information

Table 3. Ordering information

Type number	Packag	Package		
	Name	Description	Version	
BLF2324M8LS200P	-	earless flanged balanced ceramic package; 4 leads	SOT539B	

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+13	V
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C
T _{case}	case temperature	[1]	-	150	°C

^[1] Continuous use at maximum temperature will affect the MTTF.

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-c)}	thermal resistance from junction to case	$T_{case} = 80 ^{\circ}C; P_{L} = 60 W$	0.217	K/W

6. Characteristics

Table 6. DC characteristics

 $T_i = 25$ °C per section, unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 1 \text{ mA}$	65	-	-	٧
$V_{GS(th)}$	gate-source threshold voltage	V _{DS} = 10 V; I _D = 100 mA	1.5	1.9	2.3	V
I _{DSS}	drain leakage current	V _{GS} = 0 V; V _{DS} = 28 V	-	-	2.8	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $V_{DS} = 10 \text{ V}$	-	26.8	-	Α
I _{GSS}	gate leakage current	V _{GS} = 11 V; V _{DS} = 0 V	-	-	280	nA
g _{fs}	forward transconductance	V _{DS} = 10 V; I _D = 5.1 A	-	1.2	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 \text{ V};$ $I_D = 5.04 \text{ A}$	-	0.1	-	Ω

Table 7. RF characteristics

Test signal: 1-carrier W-CDMA, PAR = 7.2 dB at 0.01 % probability on the CCDF, 3GPP test model 1; 64 DPCH; f_1 = 2300 MHz; f_2 = 2400 MHz; RF performance at V_{DS} = 28 V; I_{Dq} = 1740 mA; T_{case} = 25 °C; unless otherwise specified; in a class-AB production test circuit.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Gp	power gain	$P_{L(AV)} = 60 \text{ W}$	15.8	17.2	-	dB
RLin	input return loss	P _{L(AV)} = 60 W	-	-11	-8	dB
η_{D}	drain efficiency	P _{L(AV)} = 60 W	27	32	-	%
ACPR _{5M}	adjacent channel power ratio (5 MHz)	P _{L(AV)} = 60 W	-	-37	-34	dBc

7. Test information

7.1 Ruggedness in class-AB operation

The BLF2324M8LS200P is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 28 V; I_{Dq} = 1740 mA; P_L = 200 W (CW); f = 2300 MHz.

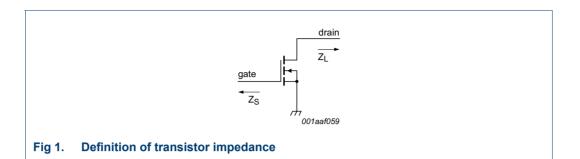
7.2 Impedance information

Table 8. Typical impedance

Measured load-pull data half section; $V_{DS} = 28 \text{ V}$; $I_{Dq} = 860 \text{ mA}$; typical values unless otherwise specified.

f	Z _S [1]	Z _L [1]
(MHz)	(Ω)	(Ω)
2300	4.24 – j6.5	1.5 – j5.4
2400	7.47 – j6.07	1.5 – j5.5

[1] Z_S and Z_L defined in Figure 1.



7.3 Test circuit

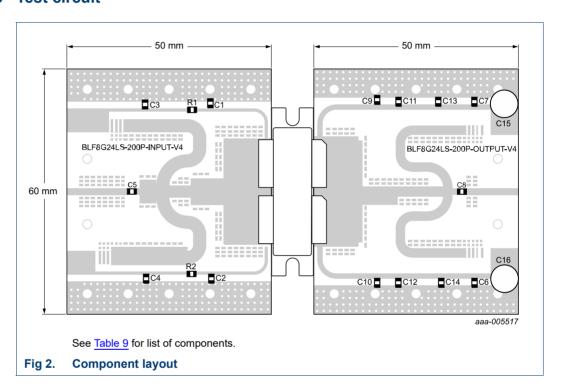


Table 9. List of components

See Figure 2 for component layout.

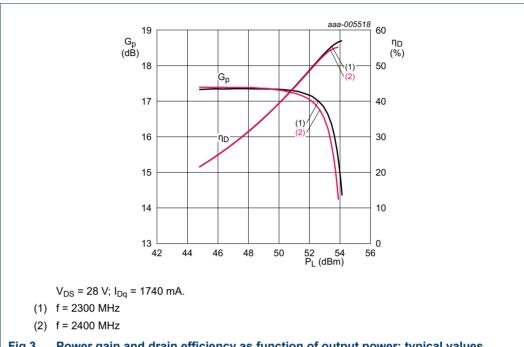
The used PCB material is Rogers RO4350B with a thickness of 0.76 mm.

Component	Description Value		Remarks	
C1, C2, C9, C10	multilayer ceramic chip capacitor	6.8 μF	[1]	
C3, C4, C6, C7	multilayer ceramic chip capacitor	1 μF	[2]	
C5, C8	multilayer ceramic chip capacitor	33 pF	[1]	
C11, C12, C13, C14	multilayer ceramic chip capacitor	0.1 μF	[2]	
C15, C16	electrolytic capacitor	1000 μF; 50 V		
R1, R2	chip resistor	5.1 Ω	[3]	

- [1] American Technical Ceramics type 100B or capacitor of same quality.
- [2] Murata or capacitor of same quality.
- [3] Vishay Dale or resistor of same quality.

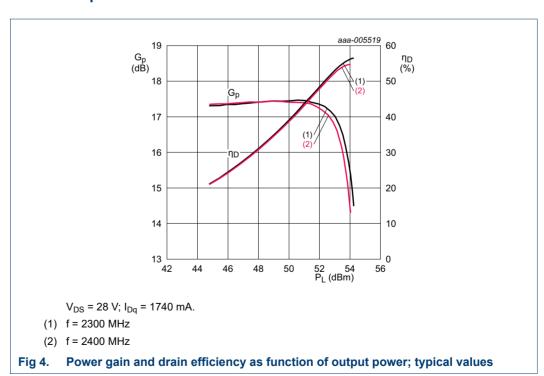
7.4 Graphical data

7.4.1 1-Tone CW

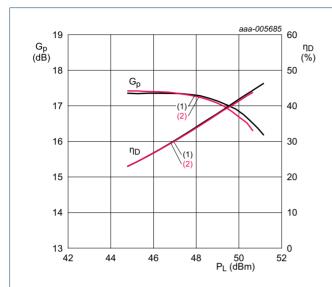


Power gain and drain efficiency as function of output power; typical values

7.4.2 1-Tone CW pulsed



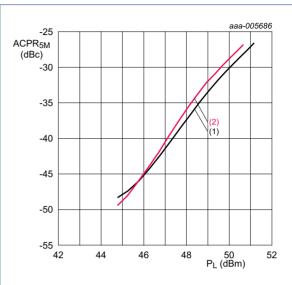
7.4.3 1-Carrier W-CDMA



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1740 \text{ mA}.$

- (1) f = 2300 MHz
- (2) f = 2400 MHz

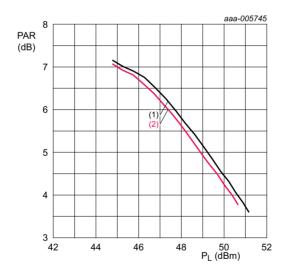
Fig 5. Power gain and drain efficiency as function of output power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1740 \text{ mA}.$

- (1) f = 2300 MHz
- (2) f = 2400 MHz

Fig 6. Adjacent power channel ratio (5 MHz) as a function of output power; typical values



 $V_{DS} = 28 \text{ V}; I_{Dq} = 1740 \text{ mA}.$

- (1) f = 2300 MHz
- (2) f = 2400 MHz

Fig 7. Peak-to-average ratio as a function of output power; typical values

8. Package outline

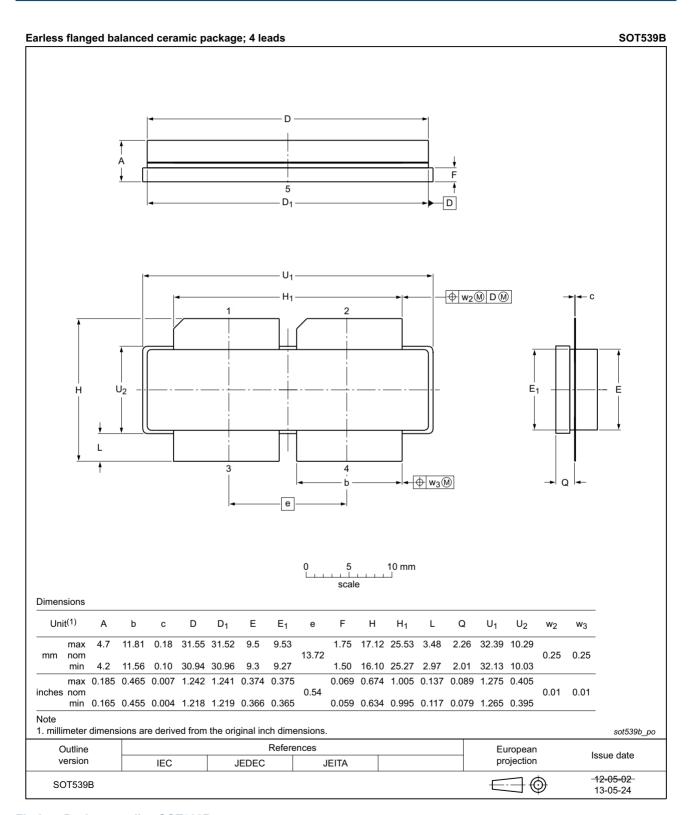


Fig 8. Package outline SOT539B

9. Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

10. Abbreviations

Table 10. Abbreviations

Acronym	Description	
3GPP	3rd Generation Partnership Project	
CCDF	Complementary Cumulative Distribution Function	
DPCH	Dedicated Physical Channel	
CW	Continuous Wave	
ESD	ElectroStatic Discharge	
LDMOS	aterally Diffused Metal Oxide Semiconductor	
MTTF	Mean Time To Failure	
PAR	Peak-to-Average Ratio	
VSWR	oltage Standing Wave Ratio	
W-CDMA	Wideband Code Division Multiple Access	

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
BLF2324M8LS200P#2	20150901	Product data sheet	-	BLF2324M8LS200P v.1
Modifications:	The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.			
	Legal texts have been adapted to the new company name where appropriate.			
BLF2324M8LS200P v.1	20140603	Product data sheet	-	-

12. Legal information

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Document status[1][2]	Product status[3]	Definition		
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.		
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.		
Product [short] data sheet	Production	This document contains the product specification.		

- [1] Please consult the most recently issued document before initiating or completing a design.
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